

Annex 3: Internal photographs to  
**TEST REPORT**  
 No.: 16-1-0092001T02a







According to:  
**FCC Regulations**  
 Part 15.207  
 Part 15.247

**IC-Regulations**  
 RSS-Gen, Issue 4  
 RSS-247, Issue 1

for  
**QSC AG**

**Vitoconnect 100, Variant OT1**  
**OpenTherm**

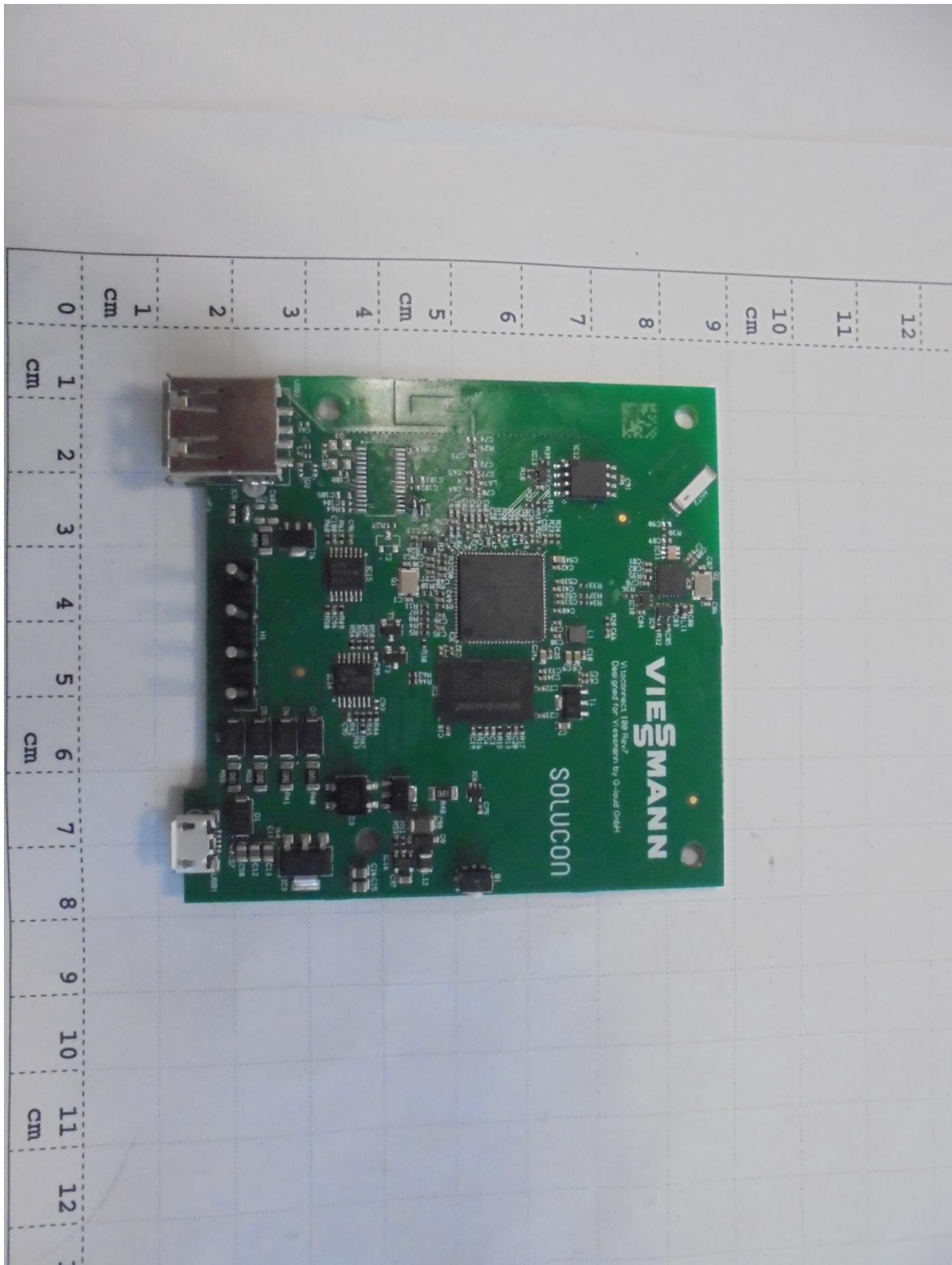
FCC-ID: 2AIZ9-VC0616  
 IC: 21680-VC0616  
 PMN: Vitoconnect 100  
 HVIN: Vitoconnect 100 OT1

Laboratory Accreditation and Listings			
 Deutsche Akkreditierungsstelle D-PL-12047-01-01	 FEDERAL COMMUNICATIONS COMMISSION • USA • MRA US-EU 0003	 Industry Canada Reg. No.: 3462D-2 Reg. No.: 3462D-3	 Voluntary Controls for Electromagnetic Emissions Reg. No.: R-2666 C-2914, T-1967, G-301
 <b>WiFi</b> ALLIANCE <b>AUTHORIZED RF LABORATORY</b>	 <b>ctia</b> Authorized <sup>TM</sup> Test Lab Lab Code: <b>20011130-00</b>		
accredited according to DIN EN ISO/IEC 17025			
<b>CETECOM GmbH</b> Laboratory Radio Communications & Electromagnetic Compatibility Im Teelbruch 116 • 45219 Essen • Germany Registered in Essen, Germany, Reg. No.: HRB Essen 8984 Tel.: + 49 (0) 20 54 / 95 19-954 • Fax: + 49 (0) 20 54 / 95 19-964 E-mail: info@cetecom.com • Internet: www.cetecom.com			

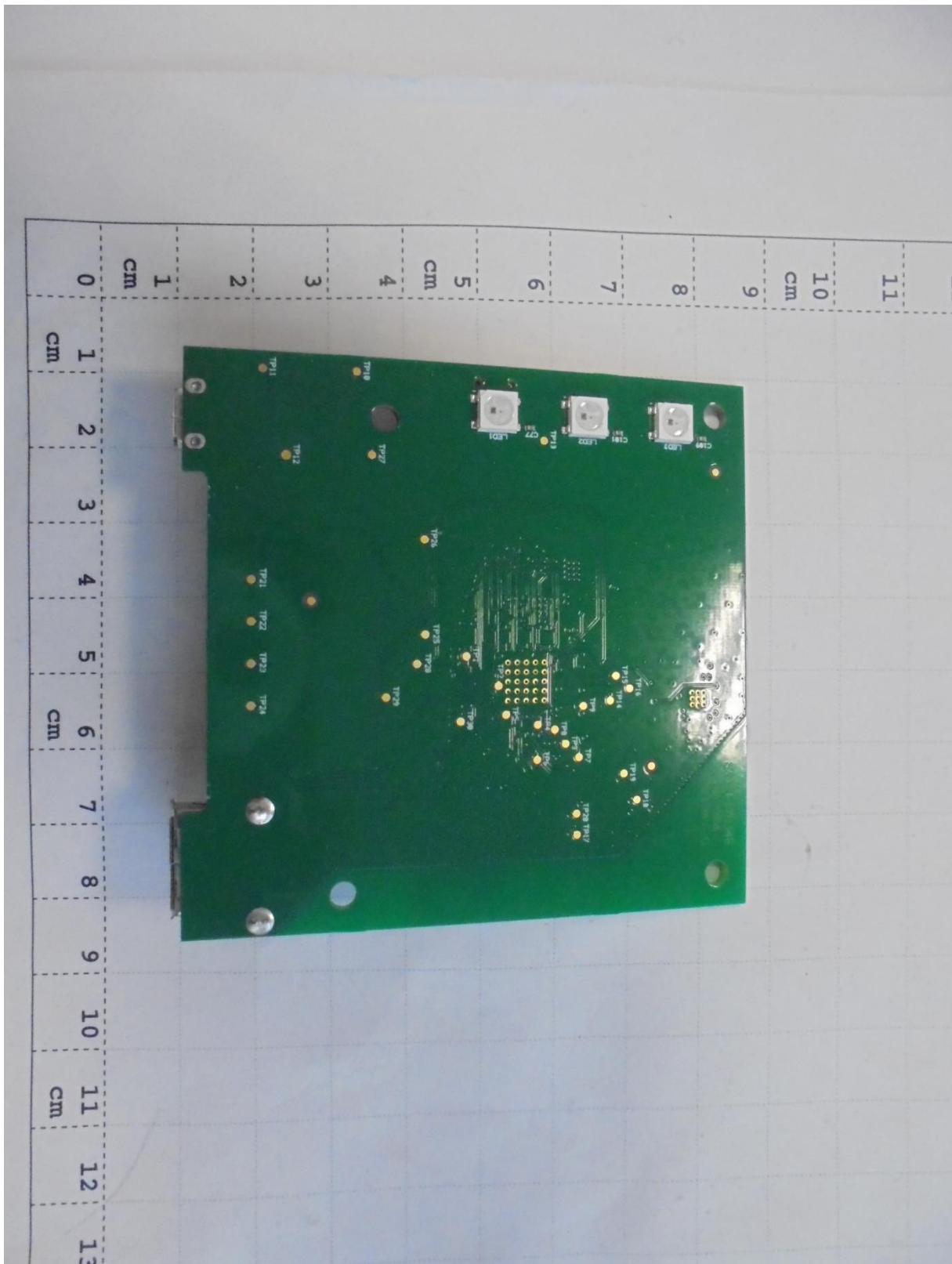
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## 1. Internal photographs

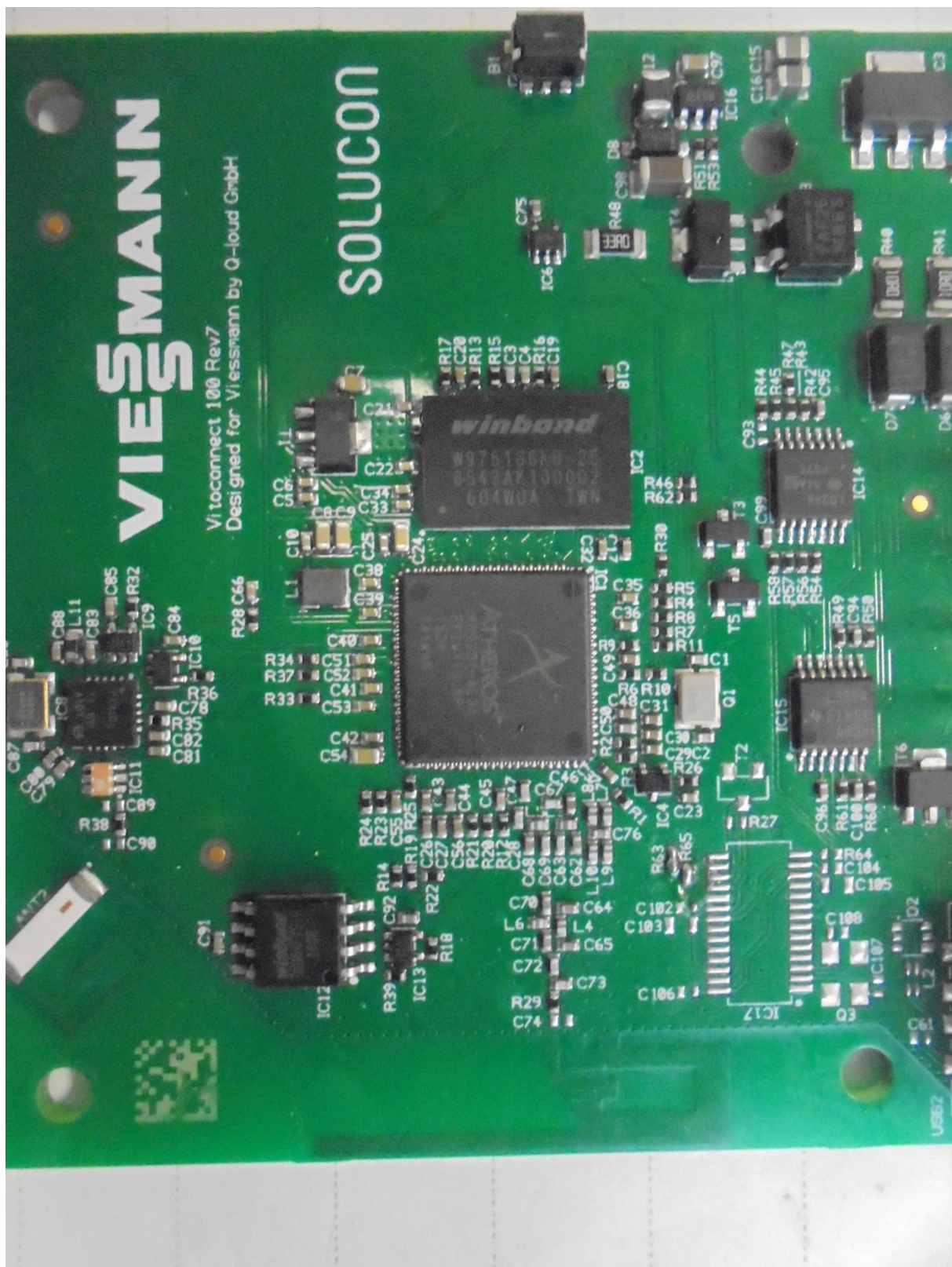


PCB Top side

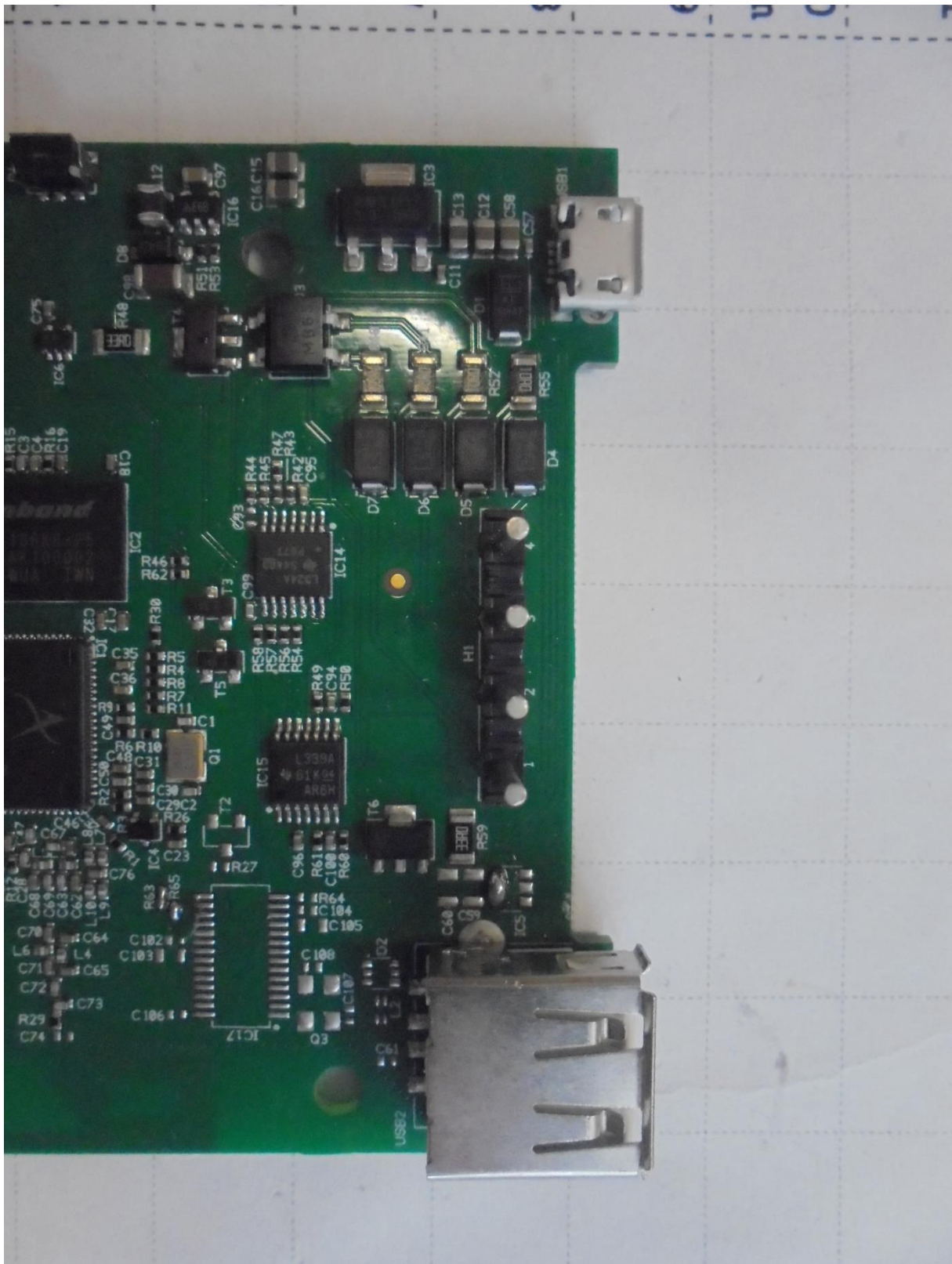


PCB under side





PCB WLAN chip area



PCB I/O area